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Description:         Second State	Part Number: 0473080001 Status: Active			
Description:       2.54mm (1007) Pitch SIM Card Holder, Guide and Holder Siyle, 6 Circuits, SMT, with Solider Tabs, Housing Height 2.00mm (0797), with 1 Securing Nail, Lead Free       Image: Control of the security of the security Nail Security Nait Security Nail Security Nail Security Nail Security Na	ACTIVE			
32 Model Drawing (PDF)       Product Specification PS-47308-001 (PDF) RoHS Certificate of Compliance (PDF)       Serie Inge - Reference only         General Product Family Series       Memory Card Sockets       Image - Reference only       Series         Comments       1 Securing Nail       ELV and RoHS       ELV and RoHS         Component Type       Card Holder (Host)       Sim_small_card       Series         Component Type       Card Holder (Host)       Sim_small_card       Series         Product Name       Sim       Sim Sim_L Card       Compliant       Compliant         Card Diffection Switch       N/A       N/A       Series       Compliant	Description: 2.54mm (.100") Pitch SIM C		Contraction of the second seco	
Drawing (PDF)       RoHS Certificate of Compliance (PDF)       Serie         Ceneral       Product Family       Memory Card Sockets       1/308         Product Family       1/308       1/308       1/308         Component Type       1/308       1/308       1/308         Overview       1/308       1/308       1/308         Overview       1/308       1/308       1/308         Overview       1/308       1/308       1/308         Physical       Card Detection Switch       N/A       1/308       1/308       1/308         Card Detection Switch       N/A       1/308 <t< td=""><td>Documents:</td><td></td><td></td></t<>	Documents:			
Seneral       Marrory Card Sockets       image - Rolerance of yz         Product Pamily       Marrory Card Sockets       image - Rolerance of yz         Series       47308       1 Securing Nail       Comments       EU Rolfs       EV and Rolfs         Comments       1 Securing Nail       Card Holder (Host)       Sim	<u>3D Model</u>	Product Specification PS-47308-001 (PDF)	The same second	
Image - Reference only         Product Family       Image - Reference only         Product Family       Image - Reference only         Comments       Card Holder (Host)         Comments       Card Holder (Host)         Overview       Sim smart_card         Product Name       SiM         System       Card Holder (Host)         Overview       Sim smart_card         Product Name       SiM         System       N/A         Darbatic Colspan="2">Condition Sivich       N/A         Counce information on product         Counce information on product <th colspa<="" td=""><td>Drawing (PDF)</td><td>RoHS Certificate of Compliance (PDF)</td><td>Sorios</td></th>	<td>Drawing (PDF)</td> <td>RoHS Certificate of Compliance (PDF)</td> <td>Sorios</td>	Drawing (PDF)	RoHS Certificate of Compliance (PDF)	Sorios
Product Family       Memory Card Sockets         Series       47.008         Comments       1 Securing Nail         Component Type       Card Holder (Host)         Overview       sim	Concret			
Series       47300         Comments       1 Securing Nail         Component Type       Card Holder (Host)         Overview       sim		Marray Orad Oradiate		
Joins     11200       Comments     1 Securing Nail       Component Type     Card Holder (Host)       Overview     sim       Product Name     SIM       Style     Guide and Holder       Type     N/A       Physical     Card Detection Switch       Card Detection Switch     N/A       Physical     6       Corructis (Loaded)     6       Corructis (Loaded)     6       Corructis (Loaded)     6       Corructis Condenses     N/A       Durability (maing cycles max)     5,000       Ejector Button     No       Ejector Button Side     N/A       Post Mating Part     Yes       Material - Netaing Maing Part     Yes       PGB Mounting Side     Normal       PCB Mounting Side     Normal       PCB Mounting Side     Normal       PCB Mounting Side     2.54mm (100')       Pitating min - Termination     0.051µm (2µ')       Pating min - Termination     0.051µm (2µ')       Pating min - Termination     0.01A       Shiedded     No       Voltage - Maxinum per Contact     0.01A       Shiedded     No       Voltage - Maxinum per Contact     0.01A       Shiedded     No       Voltage - M			EU RoHS China RoHS	
Component TypeCard Holder (Host)Overviewsmart_cardProduct NameSIMStyleGuide and HolderTypeN/APhysicalWe contains SVHC: NoCard Detection SwitchN/ACravits (Loaded)6Circuits (Loaded)6Cortor (Loaded)6Cortor (Loaded)5,000Ejector ButtonNoEjector Button SideN/ADurability (mating cycles max)5,000Ejector Button SideN/AEntry AngleVertical (Top Entry)Keying to Mating PartYesMaterial - NetalPhosphor BronzeMaterial - NetalPhosphor BronzeMaterial - ResinHigh Temperature ThermoplasticPCB Mounting SideNormalPCB Mounting SideNormalPCB Mounting SideSoftam (100)Pitch Termination0.058µm (201)Pitch Termination0.058µm (201)Ports1Temperature Range - Operating-40°C to +85°CTermination Interface2.54rm (100)Pitaing min - Mating0.058µm (201)Ports1Temperature Range - Operating-40°C to +85°CTermination Interface0.01AShieldedNoVoltage - Maximum5VSolder Process DataDuration at Max. Process Temperature (seconds)Duration at Max. Process Temperature2Duration at Max. Process Temperature2Solder Process CapabilityRefow Capable (SMT only)<				
Overview     sim_smart_card       Product Name     SIM       Style     Guide and Holder       Type     N/A       Physical     Contains SVHC: No       Circuits (Loaded)     6       Circuits (Loaded)     6       Cortains (Loaded)     6       Cortains (Loaded)     6       Cortains (Inaximum)     6       Elector Button Side     N/A       Entry Angle     Vertical (Top Entry)       Keying to Mating Part     Yes       PCB Mounting Side     Normal       PCB Locator     No       PCB Mounting Side     Normal       PCB Mounting Side     Normal       PCB Mounting Side     0.051µm (2µ')       Pitch - Termination Interface     2.54mm (100')       Plating min - Mating     0.508µm (			Compliant	
Product Name     SIM       Style     Guide and Holder       Type     N/A       Physical     Contains SVHC: No       Card Detection Switch     N/A       Crouits (maximum)     6       Color - Resin     Black       Durability (mating cycles max)     5,000       Ejector Button     No       Ejector Button Side     N/A       Entry Angle     Vertical (Top Entry)       Keying to Mating Part     Yes       Material - Netain     Phosphor Bronze       Material - Netain     Gold       Material - Netain     High Temperature Thermoplastic       PCB Mounting Side     Normal       PCB Retention     Color (Lor)       Pitch - Termination Interface     2.54mm (100')       Pitating min - Mating     0.508µm (2µ')       Ports     1       Termination Interface     2.54mm (100')       Pitating min - Mating     0.508µm (2µ')       Ports     1       Termination Interface     0.01A       Shielded     No       Uarge - Maximum     5V       Solder Process Data     No       Duration at Max. Process Temperature (second)     3       Lacetoring Type     4zio Contact Us action Us a			REACH SVHC	
Style     Guide and Holder     Low-Halogen Status       Type     N/A       Physical     Card Detection Switch     N/A       Card Detection Switch     N/A       Circuits (Loaded)     6       Cotor - Resin     Black       Durability (maing cycles max)     5,000       Ejector Button     No       Ejector Button Side     N/A       Entry Angle     Vertical (Top Entry)       Keying to Mating Part     Yes       Material - Netal     Phosphor Bronze       Material - Netal     Phosphor Bronze       Material - Netal     Phosphor Bronze       Material - Netal     Prosphor Bronze       Material - Netal     Phosphor Bronze       Material - Netal     Phosphor Bronze       Material - Netal     No       PCB Locator     No       PCB Retention     Yes       Packaging Type     Embossed Tape on Reel       Pitch - Mating Interface     2.54mm (100')       Plating min - Mating     0.508µm (2µ')       Ports     1       Termination Interface     2.54mm (100')       Plating min - Mating     0.508µm (2µ')       Ports     1       Termination Interface     0.011A       Shielded     No       Voltage - Maximum     5V </td <td></td> <td></td> <td>Contains SVHC: No</td>			Contains SVHC: No	
Orge         Date and notation           Type         NA           Physical		-	Low-Halogen Status	
Physical       N/A         Card Detection Switch       N/A         Circuits (Loaded)       6         Circuits (Loaded)       6         Color - Resin       Black         Durability (mating cycles max)       5,000         Ejector Button       No         Ejector Button Side       N/A         Entry Angle       Vertical (Top Entry)         Kaying to Mating Part       Yes         Material - Metal       Phosphor Bronze         Material - Netal       Phosphor Bronze         Material - Netal       Phosphor Bronze         Material - Netal       Phosphor Bronze         Material - Resin       High Temperature Thermoplastic         PCB Locator       No         PCB Relention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (100')         Pitatin gmin - Mating       0.508µm (20µ')         Pitating min - Mating       0.508µm (20µ')         Pots       1         Pots       -40°C to +85°C         Termination Interface       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Temperature (seconds)       3				
Physical       environmental compliance?         Card Detection Switch       N/A         Circuits (Loaded)       6         Circuits (maximum)       6         Color - Resin       Black         Durability (mating cycles max)       5,000         Ejector Button       No         Ejector Button Side       N/A         Entry Angle       Vertical (Top Entry)         Keying to Mating Part       Yes         Material - Plating Termination       Gold         Material - Plating Termination       Gold         Material - Resin       High Temperature Thermoplastic         PCB Mounting Side       Normal         PCB Mounting Side       Normal         PCB Mounting Side       Scarch Parts in this Series         Patang Into Atting Interface       2.54mm (.100')         Pitch - Maing Interface       2.54mm (.100')         Plating min - Termination Interface       2.54mm (.100')         Plating min - Termination       0.051µm (2µ')         Plating min - Termination       0.050µm (20')         Plating min - Termination       0.051µm (2µ')         Plating min - Termination       0.050µm (20')         Plating min - Termination       0.050µm (20')         Plating min - Termination <td></td> <td></td> <td>Need more information on product</td>			Need more information on product	
Card Detection Switch       N/A         Circuits (loaded)       6         Circuits (maximum)       6         Color - Resin       Black         Durability (mating cycles max)       5,000         Ejector Button Side       N/A         Ejector Button Side       N/A         Entry Angle       Vertical (Top Entry)         Keying to Mating Part       Yes         Material - Netal       Phosphor Bronze         Material - Netal       Post Sold         Material - Netal       Normal         PCB Buonting Side       Normal         PCB Retention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (.100")         Plating min - Mating       0.054µm (.20µ')         Plating min - Termination       0.054µm (.20µ')         Plating min - Termination       0.054µm (.20µ')				
Circuits (maximum)       6         Circuits (maximum)       6         Color - Resin       Black         Durability (mathing cycles max)       5,000         Ejector Button Side       N/A         Ejector Button Side       N/A         Entry Angle       Vertical (Top Entry)         Keying to Mating Part       Yes         Material - Plating Termination       Gold         Material - Plating Termination       Gold         Material - Resin       High Temperature Thermoplastic         PCB Recention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (.100")         Pitating min - Termination       0.508µm (20µ")         Plating min - Termination       0.508µm (20µ")         Plating min - Termination       0.508µm (20µ")         Pitating min - Termination       0.508µm (20µ")         Pitating min - Termination       0.508µm (20µ")         Pitating min - Termination       0.051µm (2µ")         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface: Style       Suble Stace Mount         Electrical       Current - Maximum per Contact       0.01A         Shield		N/A		
Color - Resin       Black       Compliance, click here         Durability (mating cycles max)       5,000       Please visit the <u>Contact Us</u> section for any non-product compliance questions.         Ejector Button Side       N/A       Please visit the <u>Contact Us</u> section for any non-product compliance questions.         Entry Angle       Vertical (Top Entry)       Search Parts in this Series         Material - Netal       Phosphor Bronze         Material - Plating Maing       Gold         Material - Plating Termination       Gold         Material - Plating Termination       Gold         Material - Resin       High Temperature Thermoplastic         PCB Locator       No         PCB Retention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (100°)         Plating min - Mating       0.051µm (2µ°)         Ports       1         Termination Interface       2.54mm (100°)         Plating min - Termination       0.051µm (2µ°)         Ports       1         Termination Interface       State Mount         Electrical       Current - Maximum per Contact         Current - Maximum       No         Voltage - Maximum       Sv         Solder Process D		6		
Durability (mating cycles max)       5,000         Ejector Button       No         No       No         Ejector Button Side       N/A         Entry Angle       Vertical (Top Entry)         Keying to Mating Part       Yes         Material - Netal       Phosphor Bronze         Material - Plating Termination       Gold         Material - Resin       High Temperature Thermoplastic         PCB Mounting Side       Normal         PCB Retention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (100°)         Pitating min - Mating       0.05tµm (2µ')         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface:       0.01A         Shielded       No         Voltage - Maximum       Sv         Solder Process Data       No         Durabing - Maximum       Sv         Solder Process Capability       Reflow Capable (SMT only)         Mate, Set at Max. Process Temperature       3         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Cycles at Max. Process Temperature       2         Value - Starting		6		
Ejector Button       No       Please visit the <u>Contact Us</u> section for any non-product compliance questions.         Ejector Button Side       N/A       non-product compliance questions.         Entry Angle       Vertical (Top Entry)       non-product compliance questions.         Keying to Mating Part       Yes       Search Parts in this Series         Material - Plating Mating       Gold       47308Series         Material - Resin       High Temperature Thermoplastic       PCB         PCB Locator       No       Mormal         PCB Retention       Yes       47308Series         Pttch - Mating Interface       2.54mm (140°)       Standard SIM Card         Pitch - Mating Interface       2.54mm (140°)       Standard SIM Card         Plating min - Termination       0.0508µm (20µ')       Plating min - Termination       Standard SIM Card         Plating min - Termination       0.0508µm (20µ')       Ports       1       Standard SIM Card         Electrical       Current - Maximum per Contact       0.01A       No       Voltage - Maximum       5V         Solder Process Data       Duration at Max. Process Temperature (seconds)       3       3       Electricel (SMT only)         Max. Cycles at Max. Process Capability       Reflow Capable (SMT only)       Max. Cycles at Max. Process Temperature			Compliance, <u>click here</u>	
Lettor Duttor       NO       non-product compliance questions.         Ejector Button Side       N/A       non-product compliance questions.         Entry Angle       Vertical (Top Entry)       Search Parts in this Series         Material - Netal       Phosphor Bronze       Search Parts in this Series         Material - Plating Termination       Gold       47308Series         Material - Resin       High Temperature Thermoplastic       Maters With         PCB Locator       No       No         PCB Retention       Yes       Standard SIM Card         PCB Retention       Yes       Standard SIM Card         Packaging Type       Embossed Tape on Reel       Standard SIM Card         Pitch - Mating Interface       2.54mm (100")       Hith - Termination         Plating min - Termination       0.058 µm (20µ")       Plating min - Termination         Plating min - Termination       0.051 µm (2µ")       Ports         Termination Interface:       1       Termination         Ports       1       Termination Interface:       Surface Mount         Electrical       Current - Maximum per Contact       0.01A         Shielded       No       Voltage - Maximum       Sv         Solder Process Data       Juration at Max. Process Temperature (secon		5,000	Blasse visit the Contact Lie section for any	
Lejector Button State     IVA       Entry Angle     Verical (Top Entry)       Keying to Mating Part     Yes       Material - Metal     Phosphor Bronze       Material - Plating Mating     Gold       Material - Plating Termination     Gold       Material - Resin     High Temperature Thermoplastic       PCB Locator     No       PCB Retention     Yes       Packaging Type     Embossed Tape on Reel       Pitch - Mating Interface     2.54mm (.100")       Plating min - Mating     0.054µm (2µ")       Plating min - Termination     0.051µm (2µ")       Ports     1       Temperature Range - Operating     -40°C to +85°C       Termination Interface:     Surface Mount       Electrical     0.01A       Current - Maximum per Contact     0.01A       Shielded     No       Voltage - Maximum     5V       Solder Process Data     3       Duration at Max. Process Temperature (seconds)     3       Lead-free Process Capability     Reflow Capable (SMT only)       Max. Cycles at Max. Process Temperature     2				
Keying to Mating Part     Yes       Material - Metal     Phosphor Bronze       Material - Plating Mating     Gold       Material - Plating Termination     Gold       Material - Plating Termination     Gold       Material - Resin     High Temperature Thermoplastic       PCB Locator     No       PCB Retention     Yes       Packaging Type     Embossed Tape on Reel       Pitch - Mating Interface     2.54mm (.100")       Pitch - Termination Interface     2.54mm (.100")       Plating min - Mating     0.508µm (20µ")       Plating min - Termination     0.051µm (2µ")       Ports     1       Temperature Range - Operating     -40°C to +85°C       Termination Interface: Style     Surface Mount       Electrical     Current - Maximum per Contact       Outage - Maximum     5V       Solder Process Data     Duration at Max. Process Temperature (seconds)       Duration at Max. Process Temperature     2			non-product compliance questions.	
Material - Metal     Phosphor Bronze       Material - Plating Mating     Gold       Material - Plating Termination     Gold       Material - Resin     High Temperature Thermoplastic       PCB Locator     No       PCB Rotention     Yes       Packaging Type     Embossed Tape on Reel       Pitch - Mating Interface     2.54mm (100')       Pitch - Termination Interface     2.54mm (100')       Plating min - Termination     0.0508µm (20µ')       Plating min - Termination     0.508µm (20µ')       Plating min - Termination     0.508µm (20µ')       Potter     1       Temperature Range - Operating     -40°C to +85°C       Termination Interface:     Surface Mount       Electrical     0.01A       Current - Maximum per Contact     0.01A       Shielded     No       Voltage - Maximum     5V       Solder Process Data     3       Lead-free Process Capability     Reflow Capable (SMT only)       Max. Cycles at Max. Process Temperature     2		Vertical (Top Entry)		
Material - Plating Mating       Gold       Search Parts in this Series         Material - Plating Termination       Gold       47308Series         Material - Resin       High Temperature Thermoplastic       Material - Resin         PCB Locator       No       Material - Resin       Material - Resin         PCB Mounting Side       Normal       Standard SIM Card       Mates With         PCB Retention       Yes       Standard SIM Card       Mates With         PAckaging Type       Embossed Tape on Reel       Standard SIM Card       Mates With         Pitch - Mating Interface       2.54mm (.100")       Standard SIM Card       Mates With         Plating min - Mating       0.508µm (20µ")       Plating min - Termination       Ou51µm (2µ")         Ports       1       Temperature Range - Operating       -40°C to +85°C         Termination Interface: Style       Surface Mount       Electrical         Current - Maximum per Contact       0.01A       No         Shielded       No       Sv       Solder Process Data         Duration at Max. Process Temperature (seconds)       3       Reflow Capable (SMT only)         Max. Cycles at Max. Process Temperature       2       Mate Sufface				
Material - Plating Termination       Gold         Material - Resin       High Temperature Thermoplastic         PCB Locator       No         PCB Mounting Side       Normal         PCB Retention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (.100")         Pitch - Mating Interface       2.54mm (.100")         Plating min - Mating       0.508µm (20µ")         Plating min - Termination       0.051µm (2µ")         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface:       Sturface Mount         Electrical       Uurrent - Maximum per Contact         Cuurrent - Maximum per Contact       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Data       Juration at Max. Process Temperature (seconds)         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Process Temperature       2		•		
Material - Resin       High Temperature Thermoplastic         PCB Locator       No         PCB Mounting Side       Normal         PCB Retention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (.100")         Pitch - Termination Interface       2.54mm (.100")         Plating min - Mating       0.0508µm (20µ")         Plating min - Termination       0.051µm (2µ")         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface:       Sturface Mount         Electrical       Current - Maximum per Contact         Current - Maximum       5V         Solder Process Data       Juration at Max. Process Temperature (seconds)         Juration at Max. Process Temperature       3         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Process Temperature       2	Material - Plating Mating			
PCB Locator     No       PCB Mounting Side     Normal       PCB Retention     Yes       Packaging Type     Embossed Tape on Reel       Pitch - Mating Interface     2.54mm (.100")       Pitch - Termination Interface     2.54mm (.100")       Plating min - Mating     0.508µm (20µ")       Plating min - Termination     0.051µm (2µ")       Ports     1       Temperature Range - Operating     -40°C to +85°C       Termination Interface:     Style       Stridge     Mount       Electrical     Current - Maximum per Contact       Current - Maximum     5V       Solder Process Data     Duration at Max. Process Temperature (seconds)       J     Lead-free Process Temperature       Maxes With     Standard SIM Card			47308Series	
PCB Mounting Side     Normal     Standard SIM Card       PCB Retention     Yes       Packaging Type     Embossed Tape on Reel       Pitch - Mating Interface     2.54mm (.100")       Pitch - Termination Interface     2.54mm (.100")       Plating min - Mating     0.508µm (20µ")       Plating min - Termination     0.051µm (2µ")       Ports     1       Temperature Range - Operating     -40°C to +85°C       Termination Interface:     Surface Mount       Electrical     Current - Maximum per Contact     0.01A       Shielded     No       Voltage - Maximum     5V       Solder Process Data     J       Duration at Max. Process Temperature (seconds)     3       Lead-free Process Capability     Reflow Capable (SMT only)       Max. Cycles at Max. Process Temperature     2				
PCB Retention       Yes         Packaging Type       Embossed Tape on Reel         Pitch - Mating Interface       2.54mm (.100")         Pitch - Termination Interface       2.54mm (.100")         Plating min - Mating       0.508µm (20µ")         Plating min - Termination       0.051µm (2µ")         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface: Style       Surface Mount         Electrical       0.01A         Current - Maximum per Contact       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Data       Juration at Max. Process Temperature (seconds)         Jacadet free Process Temperature       2			Mates With	
Packaging TypeEmbossed Tape on ReelPitch - Mating Interface2.54mm (.100")Pitch - Termination Interface2.54mm (.100")Pitth - Termination Interface2.54mm (.100")Plating min - Mating0.508µm (20µ")Plating min - Termination0.051µm (2µ")Ports1Temperature Range - Operating-40°C to +85°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact0.01AShieldedNoVoltage - Maximum5VSolder Process DataDuration at Max. Process Temperature (seconds)3 Lead-free Process CapabilityMax. Cycles at Max. Process Temperature2			Standard SIM Card	
Pitch - Mating Interface2.54mm (.100")Pitch - Termination Interface2.54mm (.100")Pitth - Termination Interface2.54mm (.100")Plating min - Mating0.508µm (20µ")Plating min - Termination0.051µm (2µ")Ports1Temperature Range - Operating-40°C to +85°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact0.01AShieldedNoVoltage - Maximum5VSolder Process DataDuration at Max. Process Temperature (seconds)3Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature2			, <u> </u>	
Pitch - Termination Interface2.54mm (.100")Plating min - Mating0.508µm (20µ")Plating min - Termination0.051µm (2µ")Ports1Temperature Range - Operating-40°C to +85°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact0.01AShieldedNoVoltage - Maximum5VSolder Process DataDuration at Max. Process Temperature (seconds)3Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature2				
Plating min - Mating       0.508µm (20µ")         Plating min - Termination       0.051µm (2µ")         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface: Style       Surface Mount         Electrical       0.01A         Current - Maximum per Contact       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Data       Juration at Max. Process Temperature (seconds)         J       3         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Cycles at Max. Process Temperature       2	e e e e e e e e e e e e e e e e e e e			
Plating min - Termination       0.051µm (2µ <sup>in</sup> )         Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface: Style       Surface Mount         Electrical       0.01A         Current - Maximum per Contact       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Data       Juration at Max. Process Temperature (seconds)         Juration at Max. Process Temperature (seconds)       3         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Cycles at Max. Process Temperature       2				
Ports       1         Temperature Range - Operating       -40°C to +85°C         Termination Interface: Style       Surface Mount         Electrical       0.01A         Current - Maximum per Contact       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Data       Juration at Max. Process Temperature (seconds)         Juration at Max. Process Temperature (seconds)       3         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Cycles at Max. Process Temperature       2				
Temperature Range - Operating Termination Interface: Style-40°C to +85°C Surface MountElectrical0.01ACurrent - Maximum per Contact Shielded Voltage - Maximum0.01AShielded Voltage - Maximum5VSolder Process Data3Duration at Max. Process Temperature (seconds) Lead-free Process Capability3Kendow Capable (SMT only)8Max. Cycles at Max. Process Temperature2				
Termination Interface: Style     Surface Mount       Electrical     0.01A       Current - Maximum per Contact     0.01A       Shielded     No       Voltage - Maximum     5V       Solder Process Data     5V       Duration at Max. Process Temperature (seconds)     3       Lead-free Process Capability     Reflow Capable (SMT only)       Max. Cycles at Max. Process Temperature     2		•		
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Current - Maximum per Contact       0.01A         Shielded       No         Voltage - Maximum       5V         Solder Process Data       5V         Duration at Max. Process Temperature (seconds)       3         Lead-free Process Capability       Reflow Capable (SMT only)         Max. Cycles at Max. Process Temperature       2	Electrical			
Shielded     No       Voltage - Maximum     5V       Solder Process Data     Solder Process Temperature (seconds)       Duration at Max. Process Temperature (seconds)     3       Lead-free Process Capability     Reflow Capable (SMT only)       Max. Cycles at Max. Process Temperature     2		0.01A		
Voltage - Maximum5VSolder Process Data3Duration at Max. Process Temperature (seconds)3Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature2				
Duration at Max. Process Temperature (seconds)3Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature2				
Duration at Max. Process Temperature (seconds)3Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature2	Solder Process Data			
Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature2		3		
Max. Cycles at Max. Process Temperature 2				

Material Info

Reference - Drawing Numbers

Packaging Specification Product Specification Sales Drawing

PK-47308-001 PS-47308-001 SD-47308-001

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